



Radiation damage on FBK SiPMs

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Silicon Photomultipliers







FBK SiPM technologies



RGB RGB-HD









Ultra high cell density (Very small cells)



SiPM and radiation damage



<u>High fluences</u> in HEP experiments ...



Irradiation test to check SiPMs radiation hardness

Fluence	I _{dark} , DCR	GAIN	PDE	Rq	V _{bd}	
Medium ф < 10 ¹² cm ⁻²	x(↑)					
High φ > 10 ¹² cm ⁻²	x(↑)	x(↓)	x(↓)	x (↑)	x (↑)	



Gaussian beam at 61MeV with a non uniform irradiation along the sensors surface



Energy shift between the first and the last SiPM in the block





Irradiation tests with protons



- > 10 technologies in a fluence range $(1.7 \times 10^8 \div 1.7 \times 10^{12}) n_{eq}/cm^2$
- ➢ SiPM type:
 - $1x1mm^2 \div 1.75mm^2$ active area
 - Placed on bigger chip (test chip)
 - Different pitches
- > All SiPMs have been annealed at room temperature for \sim 1month before measurement

TECHNOLOGY	Characteristics	Cell pitch [µm]									
RGB – HD 2016	P-type substrate. Peak sensitivity 550nm.					20	25	30	35		
NUV – HD lowCT 2015	N-type substrate. peak sensitivity 400nm.						25	30	35	40	
RGB – UHD LF 2017	Ultra high density. Lower electric field.	7.5	10	12	15						
NUV-HD ULF 2019	Lower electric field. Small cell pitch.			12	15						



Main investigation parameters



CURRENT

- Leakage: pre-breakdown current
- **Dark current**: post-breakdown current

DARK COUNT RATE

<u>Primary noise</u> due to deep-levels into the silicon, thus crucially affected by the damage



PHOTON **D**ETECTION **E**FFICIENCY PDE = $Q_e \times P_t \times FF$



CORRELATED NOISE

- Cross-Talk (optical) between cells
- Afterpulsing





Results – Current





- Significant increase from 1×10^9 p/cm²
- Dark current increasing of 2.5 decades after 1×10¹¹ p/cm²



Results – Dark current increment



Useful information from the increase of dark current at excess bias 5V at +20C

$$r = \frac{I_{after}}{I_{before}}$$

- Linear, then more than linear increment.
- Saturation at high fluences.
- More than factor 10⁵ increment in noise at 10¹¹ proton/mm²





Results – Dark Count Rate (primary noise)





Method \rightarrow analysis of pulses: <u>Inter-arrival times</u>

- Peaks identification
- Amplitude calculation
- Inter-arrival time estimation

Method widely used in SiPM characterization,

BUT no longer usable when pulses are no more clearly distinguishable!



Results – Dark Count Rate (primary noise)



Current method

$$DCR(V) = \frac{I_{dark}(V)}{q \times G(V) \times ECF(V)} = \frac{1}{q} \frac{I_{dark}(V)}{G_c(V)}$$

- Pulsed 420nm LED connected to a fiber at -20C
- Charge integration Q
- Number of photons counting







Results – Optical Crosstalk between cells





- Evidence of a slight increase of the DiCT due to the high noise
- Low efficiency in the program for highly damaged SiPM
- Correction factor useful to fix the issue

$$p = 1 - \left[1 - \frac{DCR_{1.5}}{DCR_{0.5}}\right] \cdot \exp(DCR_{0.5} \cdot \tau)$$

Clear improvement visible in the results



Results – Photon Detection Efficiency





PDE constant up to $1.2x10^8 \text{ p/mm}^2$

Still no efficient method for estimation of PDE at high fluences due to the noise

From Gc measure PDE not changing with fluence up to $\sim 10^9 p/mm^2$



Results – Breakdown voltage

Interesting to determine if breakdown voltage is changing after irradiation: used several methods to identify V_{bd}

- 1. Maximum of First Logarithmic Derivative (FLD)
- 2. Maximum of Second Logarithmic Derivative (SLD)
- 3. Minimum of Inverse Logarithmic Derivative (ILD)
- 4. Maximum of Normalized First Derivative (NFD)
- 5. Bias at Amplitude equal to zero (A)
- 6. Bias at Gain equal to zero with only two points (G_2)
- 7. Bias at Gain equal to zero with all points (G_{all})

 V_{bd} constant up to $2.3 \times 10^9 \text{ p/mm}^2$







Results – Arrhenius plot and Activation Energy





Activation energy extracted from linear fit of Current vs 1000/T in range (-15÷15)°C

At least two E_a levels and clear saturation effects



Results – Emission Microscopy





In SPADs secondary photons emission in avalanche multiplication process.



Results – Emission Microscopy





Counting of points inside and outside the internal circle changing the intensity thresholds





Results – Emission Microscopy





- Hotspots mostly located on the border of the cells
- Further upgrades of the study will hopefully lead to a full localization of the defects in the cell



Conclusions

- Significantly worsening of the CURRENT between 10⁸ and 10¹¹ p/mm²
- > Trend of I_{after}/I_{before}
 - No linearity with fluence *I_{after}/I_{before}*
 - Possible saturation effect starting between 10¹⁰ and 10¹¹ p/mm²
- Increase of the DCR as expected from literature
 - Up to 6 order of magnitude increment between $0 10^{11} \text{ p/mm}^2$
 - Significant bulk damage
 - No changes in gain current
- > No significant changes in **DiCT**, V_{bd} and **Gain**
 - No significant variation in doping concentrations.
- Decrease of the activation energy with some saturation effects at high fluences
- High defect concentration on the border of the cells from EMMI measurement





THANK YOU